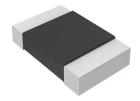


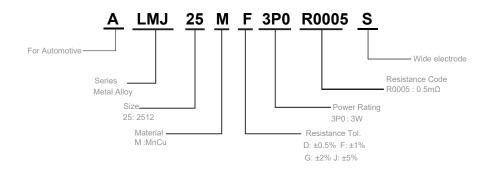




- Proprietary processing technique produces extremely low resistance values
- Very low inductance
- Low thermal EMF
- Metallic Material



Part Numbering System



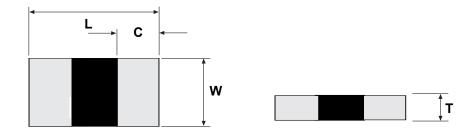
Parameter	Standard
Power Rating	3W
Resistance Value	0.5mΩ
Operating Temperature Range	-55 to +170°C
Component Temperature Coefficient (TCR)	100 ppm/°C
Maximum Working Voltage (V)	(P x R) ^{1/2}
Rating Current (A)	(P / R) ^{1/2}
·	

Standard Electrical Specifications

Туре	Rating Power at 70℃	T.C.R. (ppm/°ℂ)	Resistance Range(m Ω) $\pm 0.5\%$ (D) $\pm 1.0\%$ (F) $\pm 2.0\%$ (G) $\pm 5.0\%$ (J)	Meterial	Electrode	Operating Temperature(℃)
ALMJ25	3W	100	0.5	Alloy	Wide	-55~+170°C



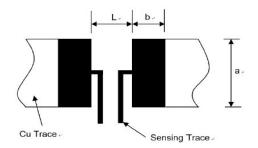
Construction



Unit: Millimeters

Style	Resistance (mΩ)	L	W	С	Т	Material
ALMJ25	0.5	6.4±0.2	3.2±0.2	2.5±0.2	0.9 ±0.20	MnCu

Recommended land pattern



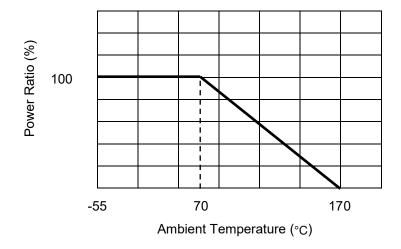
Unit: Millimeters

Resistance Range (mΩ)	а	b	L
0.5	4.0±0.1	3.1±0.1	1.3±0.1

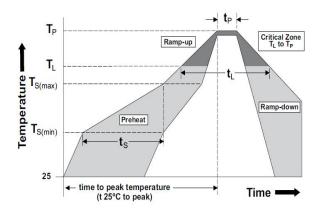


Power Derating Curve

For resistors operated in ambient temperatures 70°C, power rating shall be derated inaccording with the curve below:



Recommended Solder Curve



Reflow Cond	dition	Pb – Free assembly		
	- Temperature Min (Ts(min))	150°C		
Pre heat	- Temperature Max (Ts(max))	200°C		
	- Time (Min to Max) (ts)	60 – 120 secs		
	Average ramp up rate uidus Temp (TL) to peak	5°C/second max		
TS(max) to TL - Ramp-up Rate	5°C/second max		
Reflow	- Temperature (TL) (Liquidus)	217°C		
	- Temperature (tL)	60 – 150 seconds		
	Peak Temperature (TP)	260°C		
Time within 5	s°C of actual peak Temperature (tp)	20 - 40 seconds		
	Ramp-down Rate	5°C/second max		
Time 2	5°C to peak Temperature (TP)	8 minutes Max.		
	Wave Soldering	260°C, 10 seconds max.		
	Hand Soldering	350°C, 5 seconds max.		

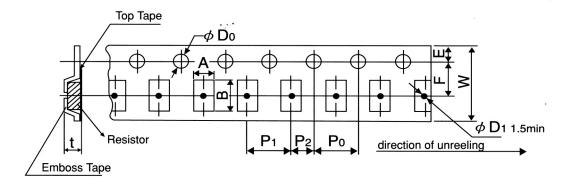


Product Characteristics

Item	Test condition/ Methods	Limited	Standard
Resistance	Measuring resistance value at room temperature 25°C±5°C	Refer to Spec	IEC60115-1 4.5
Temperature coefficient of resistance	TCR =(R-R ₀)/R ₀ (T2-T1)X 10 ⁶ R ₀ : resistance of room temperature R: resistance of 125 $^{\circ}$ C T1: Room temperature T2: Temperature at 125 $^{\circ}$ C	Refer to Spec	MIL-STD-202 Method 304
Short time Overload	Apply overload for 5 seconds and measure the resistance change rate after standing for 24 hours. 5 times the rated power for 5 seconds	≤±0.5%	MIL-R-26E
Resistance to Soldering Heat	260°C±5°C time: 10sec±1sec	≤±0.5%	MIL-STD-202 Method 210
Temperature Cycling	-55℃ (15min)/+150℃(15min), 1000 cycles	≤±0.5%	MIL-STD-202 Method107G
Low temperature Storage	-55±2℃ for 96hours, No power	≤±0.5%	MIL-STD-26E
High Temperature Storage	170℃ for 1000 hours, No power	≤±1%	IEC6011501-4.25
Bias Humidity	+85℃,85% RH,10%bias, 1000hours	≤±0.5%	MIL-STD-202 Method103
Solderability	245±5°C, 3±1sec	At least 95% of surface area of electrode shall be covered with new solder	IEC60115-1-4.17 JIS-C5201-4.17
Operational life	Operational life 70°C± 2°C, 1000 hours, at rated power 1.5 hours "ON", 0.5 hours "OFF"		MIL-STD-202 Method 108
Terminal Strength	Weld it into the bending test plate, place it on the bending test machine, apply 2.5kg force in the center of the test plate, press 2mm under the load for 60s, and measure the resistance change rate.	≤±0.5%	JIS-C5201-1 4.32

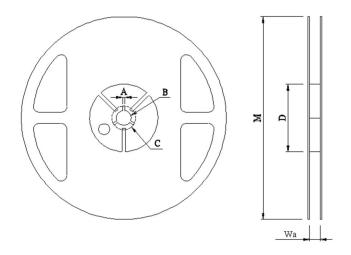


Tapping & Package



Туре	Pack	A ±0.2	B ±0.2	D0 +0.5-0	E ±0.1	F ±0.05	P0 ±0.1	P1 ±0.1	P2 ±0.1	W ±0.2	D1 ±0.05	T ±0.15
2512	Emboss	3.60	6.90	1.50	1.75	5.50	4.00	4.00	2.00	12.00	1.50	1.20

Reel Specification



Unit: Millimeters

Туре	Α	В	С	D	M	W
2512	2.00±0.5	13.50±0.5	21.00±0.5	60.00±1.0	178.00±2.0	13.80±0.5

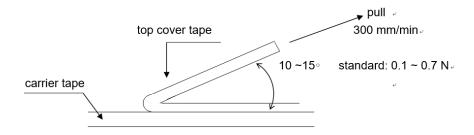
Packaging

Quantity: 4, 000pcs

8mm wide tape on 178mm(7 inch) diameter reel -specification EIA Standard 481.

Peel strength of upper belt

Stripping speed: 300 mm / min; The peel force is between 0.1N and 0.7n.



Storage conditions & shelf life

It can be stored for 2 years under closed conditions with temperature of 5 $^{\circ}$ C \sim 35 $^{\circ}$ C and relative humidity of 40 \sim 75

Please avoid the following harsh environment during storage to avoid affecting the product performance and solder connectivity: the places with corrosive gases such as sea breeze, Cl2, H2S, NH3, SO2 and NO2 shall be stored without direct sunlight.

Precautions for product use

When measuring the resistance value before welding, a special resistance meter with high precision shall be used. When measuring, a 4-wire probe or fixture must be used. 4. When measuring parts with a wire measuring needle, the 4 measuring needles must indeed contact the parts.

Avoid damaging the protective layer during manual welding or clamping with tweezers.

When the PCB is divided or fixed on the support, be careful to avoid excessive bending causing mechanical stress to the resistor.

It shall be used within the rated power range within the specification, especially when the power exceeds the rated value, which may affect the reliability of the product